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E				Change CAGE code to 67268. Add $ m V_{CC}$ to tes $ m r$ table I. Editorial changes throughout.											1989	MA	Y 18	3	24	0.	4	K			
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STANDARDIZED MILITARY DRAWING					CHECKED BY APBROXIBLE APBROX						MICROCIRCUIT, LINEAR, DUAL DIFFERENTIAL LINE DRIVERS, MONOLITHIC SILICON														
THIS DRAWING IS AVAILABLE FOR USE BY ALL DEPARTMENTS AND AGENCIES OF THE DEPARTMENT OF DEFENSE				DRAWING APPROVAL DATE 12 APRIL 1979						SIZE			49		-		7	'90)09)					
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DISTRIBUTION STATEMENT A. Approved for public release; distribution is unlimited.

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1. SCOPE								
1.1 <u>Scope</u> . This drawing describes dev with 1.2.1 of MIL-STD-883, "Provisions for non-JAN devices".	ice reduirement r the use of MIL	s for class B microcirc STD-883 in conjunctio	uits in accordance n with compliant					
1.2 Part number. The complete part number	iber shall be a	s shown in the followin	g example:					
Drawing number Device (1.2.	.1)	(1.2.2)	X 					
1.2.1 Device type. The device type sha		e circuit function as f	ollows:					
Device type Generic number	****	Circuit function	-					
01 7830, 55183		Dual differential lin						
1.2.2 <u>Case outlines</u> . The case outlines as follows:	s shall be as de	signated in appendix C	of MIL-M-38510, and					
Outline letter	Case ou							
U F-2 (14-1e	ad390" x .260	" x .085"), flat packa " x .200"), dual-in-li " x .085"), flat packa .358" x .100"), square	3e					
1.3 Absolute maximum ratings.								
Supply voltage (V _{CC}) 1/ Input voltage Output short circuit duration 2/ - Lead temperature (soldering, 10 sec Storage temperature range Power dissipation (P _D) Thermal resistance, junction-to-cas Junction temperature (T _J)	onds)	- 1 second - +300°C 65°C to +150°C - 600 mW 3/.4/ - See MIL-M-38510, ap	ppéndix C					
1.4 Recommended operating conditions.								
Supply voltage (V_{CC})	(T _A)	- 4.5 V dc to 5.5 V d 40 mA maximum - 40 mA maximum - 55°C to +125°C	lc					
/ ATT voltage values, except differential voltages, are with respect to network ground terminal. / At +125°C not more than one output should be shorted to ground at a time. / Derate 10.4 mW/°C above T _A = +90°C. / Must withstand the added P _D due to short circuit test, e.g., I _{OS} .								
STANDARDIZED	SIZE A		_					
MILITARY DRAWING	Α		79009					
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2. APPLICABLE DOCUMENTS

2.1 Government specification and standard. Unless otherwise specified, the following specification and standard of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510

- Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-883

Test Methods and Procedures for Microelectronics.

(Copies of the specification and standard required by manufacturers in connection with specific acquisition functions should be obtained from the contracting activity or as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the test of this drawing shall take precedence.

REQUIREMENTS

- 3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjuction with compliant non-JAN devices" and as specified herein.
- 3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.
 - 3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.
 - 3.2.2 <u>Case outlines</u>. The case outlines shall be in accordance with 1.2.2. herein.
- 3.2.3 Voltage waveforms and test circuit. The voltage waveforms and test circuit shall be as specified on figure 2.
- 3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristiscs are as specified in table I and apply over the full ambient operating temperature range.
- 3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.
- 3.5 Certificate of compliance. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.
- 3.6 Certificate of conformance. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

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TABLE I. Electrical performance characteristics. Contitions Limits 4.5 V & VCC & 5.5 V -55 C & TA < +125 C unless otherwise specified Group A Symbol 1 Unit Test Min Max subgroups High level input ٧ ΥtΗ 1, 2, 3 2.0 voltage Low level input VIL 1, 2, 3 0.8 ٧ voltage High level output **VOH** VIH = 2.0 V $I_{OH} = -0.8 \text{ mA}$ ٧ 1, 2, 3 2.4 voltage (Y output) $11_{OH} = -40 \text{ mA}$ 1.8 Low level output $V_{IL} = 0.8 \text{ V}, I_{OL} = 40 \text{ mA}$ VOL 1, 2, 3 0.4 ٧ voltage (Y output) High level output voltage (Z V_{IL} = 0.8 V $I_{OH} = -0.8$ mA **VOH** 1, 2, 3 2.4 ٧ output) $I_{OH} = -40 \text{ mA}$ 1.8 Low level output $V_{IH} = 2.0 V$, $I_{OL} = 40 \text{ mA}$ 1, 2, 3 I VOL 0.5 ٧ voltage (Z output) High level input IIH $V_{IH} = 2.4 V$ 1, 2, 3 120 μΑ čurrent VIH = 5.5 V 2 mΑ Low level input IIL $V_{IL} = 0.4 V$ 1, 2, 3 -4.8 mΑ current Short circuit $V_{CC} = 5 \text{ V}, T_A = +125^{\circ}C$ Ios 2 -40 -120 mΑ output current ICC $V_{CC} = 5 V$ 1, 2, 3 Supply current 18 mΑ (average per driver) See footnotes at end of table. SIZE STANDARDIZED A 79009 **MILITARY DRAWING DEFENSE ELECTRONICS SUPPLY CENTER REVISION LEVEL** SHEET

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	TABLE	I. Electrical performance characterist	<u>ics</u> - Continu	ued.		
Test	 Symbol 	Conditions 4.5 V < VCC < 5.5 V -55°C < TA < +125°C unless otherwise specified	Group A subgroups	Lim Min	its Max 	 Unit
Propagation delay time low to high (Y output) <u>1</u> /	 t _{PLH1} 	 C _L = 15 pF, V _{CC} = 5.0 V	9 10,11 2/		 12 17	 ns
Propagation delay time high to low	t _{PHL1}	 	9	<u></u>	18	l ns
(Y output) <u>1</u> /	 		10,11 2/		25 	
Propagation delay time low to high (Z output) 1/	t _{PLH2}	C _L = 15 pF, V _{CC} = 5.0 V	9		12	ns
Propagation delay	 	 	10,11 2/	<u>.</u>	17 8	l I ns
time high to low (Z output) 1/	CPHL2	V _{CC} = 5.0 V	10,11 2/		11	3
Propagation delay time low to high (differential output) 1/		$R_L = 100\Omega$, $C_L = 5,000 pF$ (Y output with respect to Z output) $ T_A = +25°C $	9		16	ns
Propagation delay time high to low (differential output) 1/	tpHL3	$R_{L} = 100\Omega$, $C_{L} = 5,000$ pF (Y output with respect to Z output) $T_{A} = +25^{\circ}C$	9		16	ns

^{1/} See figure 2.

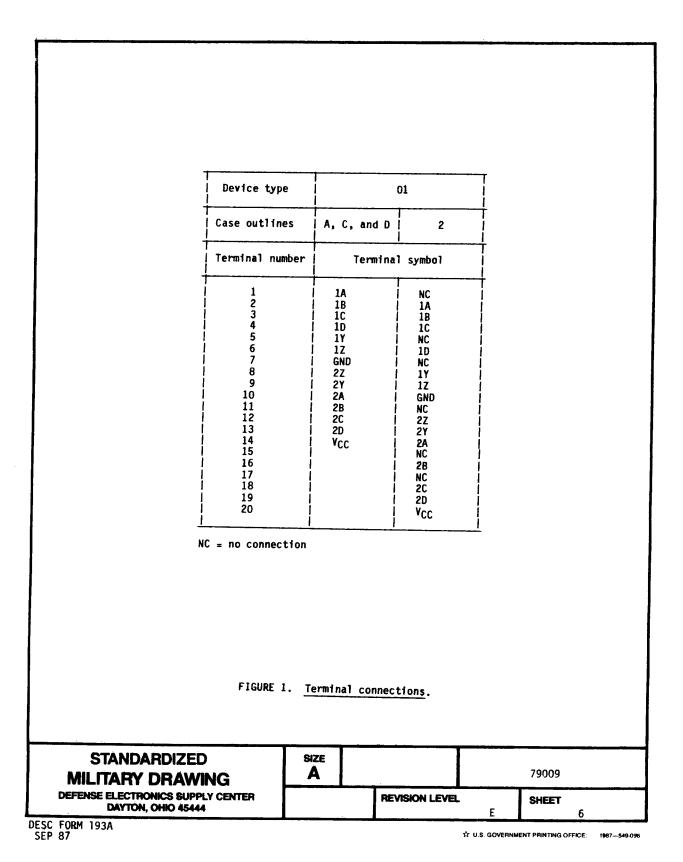
- 3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-STD-883 (see 3.1 herein).
- 3.8 <u>Verification and review</u>. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.
 - 4. QUALITY ASSURANCE PROVISIONS
- 4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

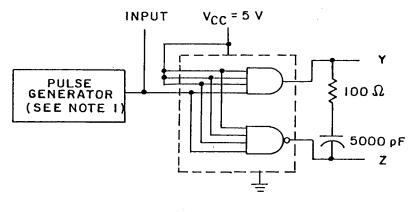
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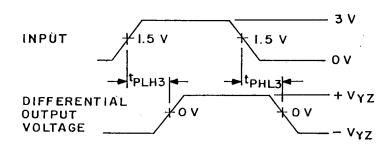
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^{2/} Guaranteed, if not tested, to the limits specified.





TEST CIRCUIT



VOLTAGE WAVEFORMS DIFFERENTIAL OUTPUT

PRR = 1 MHz

NOTES:

1. The pulse generator has the following characteristics.

$$Z_0 = 50\Omega$$
 $t_f = 10 \text{ ns}$ $t_r = 10 \text{ ns}$ $t_w = 0.5 \text{ } \mu\text{s}$

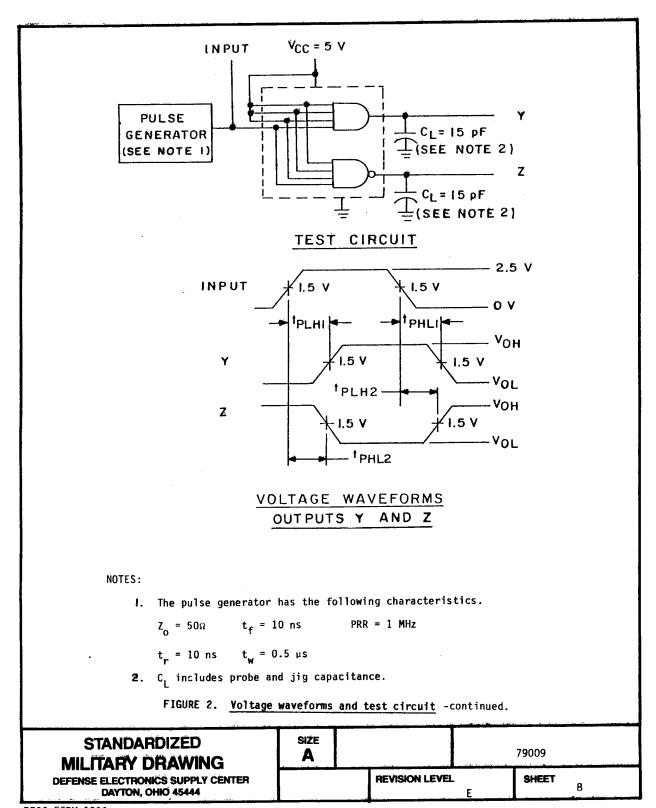
2. C_{\parallel} includes probe and jig capacitance.

FIGURE 2. Voltage waveforms and test circuit.

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- 4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:
 - a. Burn-in test, method 1015 of MIL-STD-883.
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_A = +125$ °C, minimum.
 - b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.
- 4.3 Quality conformance inspection. Quality conformance inspection shall be in accordance with method $\frac{5005}{100}$ of MIL-STD-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.
 - 4.3.1 Group A inspection.
 - a. Tests shall be as specified in table II herein.
 - b. Subgroups 4, 5, 6, 7, and 8 in table I, method 5005 of MIL-STD-883 shall be omitted.
 - 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test conditions, method 1005 of MIL-STD-883:
 - Test condition A, B, C, or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) $T_{\Delta} = +125^{\circ}C$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by method 1005 of MIL-STD-883.

TABLE II. Electrical test requirements.

MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
 Interim electrical parameters (method 5004)	
 Final electrical test parameters (method 5004)	 1*, 2, 3, 9
 Group A test requirements (method 5005)	 1, 2, 3, 9,
 Groups C and D end-point electrical parameters (method 5005)	1, 2, 3

PDA applies to subgroup 1. * Subgroups 10 and 11, if not tested, shall be guaranteed to the specified limits in table I.

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- 5. PACKAGING
- 5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.
 - 6. NOTES
- 6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for DEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on QPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item for all applications.
- 6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.
- 5.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, OH 45444, or telephone 513-296-5375.
- 6.4 Approved source of supply. An approved source of supply is listed herein. Additional sources will be added as they become available. The vendor listed herein has agreed to this drawing and a certificate of compliance (see 3.5) has been submitted to DESC-ECS.

 Military drawing part number	Vendor CAGE number	Vendor similar part number 1/	Replacement
7900901AX	2/	DS7830W	
7900901CX	01295	SNJ55183J	
7900901DX	01295	SNJ55183W	
79009012X	01295	SNJ55183FK	

- $\frac{1}{}$ Caution. Do not use this number for item acquisition. Items acquired to this number may not satisfy the performance requirements of this drawing.
- 2/ Inactive for new design. Unavailable from an approved source of supply.

Vendor CAGE number

01295

Vendor name and address

Texas Instruments, Incorporated P.O. Box 60448 Midland, TX 79711-0448

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